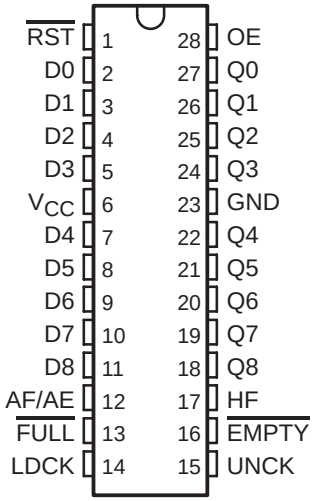
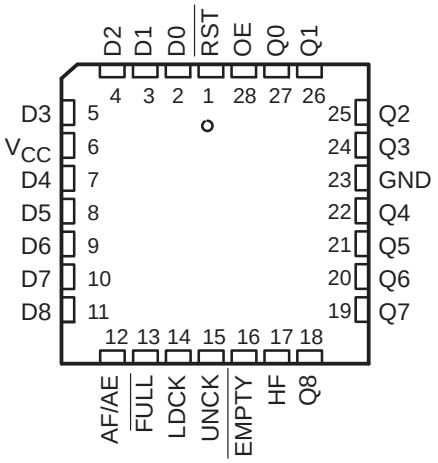
- **Independent Asynchronous Inputs and Outputs**
- **64 Words by 9 Bits**
- **Data Rates From 0 to 40 MHz**
- **Fall-Through Time . . . 20 ns Typical**
- **3-State Outputs**

N PACKAGE
(TOP VIEW)



FN PACKAGE
(TOP VIEW)



description

This 576-bit memory uses advanced low-power Schottky IMPACT-X™ technology and features high speed and fast fall-through times. It is organized as 64 words by 9 bits.

A FIFO memory is a storage device that allows data to be written into and read from its array at independent data rates. The function is used as a buffer to couple two buses operating at different clock rates. This FIFO is designed to process data at rates from 0 to 40 MHz in a bit-parallel format, word by word.

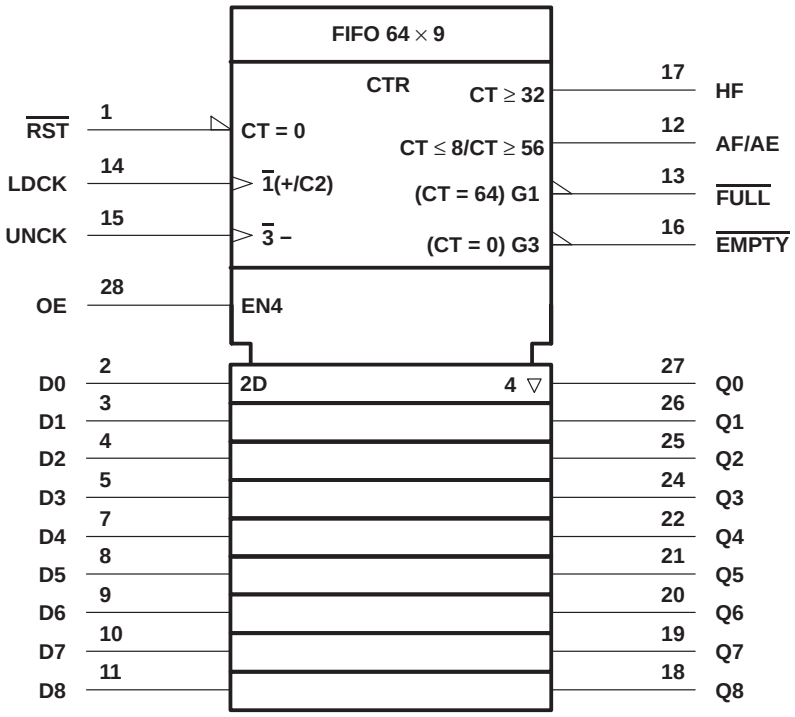
Data is written into memory on a low-to-high transition of the load clock (LDCK) input and is read out on a low-to-high transition of the unload clock (UNCK) input. The memory is full when the number of words clocked in exceeds by 64 the number of words clocked out. When the memory is full, LDCK signals have no effect on the data residing in memory. When the the memory is empty, UNCK signals have no effect.

Status of the FIFO memory is monitored by the $\overline{\text{FULL}}$, $\overline{\text{EMPTY}}$, almost-full/almost-empty (AF/AE), and half-full (HF) output flags. The $\overline{\text{FULL}}$ output is low when the memory is full and high when the memory is not full. The $\overline{\text{EMPTY}}$ output is low when the memory is empty, and high when it is not empty. The AF/AE flag is high when the FIFO contains eight or less words or 56 or more words. The AF/AE flag is low when the FIFO contains between nine and 55 words. The HF flag is high when the FIFO contains 32 or more words and is low when the FIFO contains 31 words or less.

A low level on the reset ($\overline{\text{RST}}$) input resets the internal stack control pointers and also sets $\overline{\text{EMPTY}}$ low and $\overline{\text{FULL}}$ high. The outputs are not reset to any specific logic levels. The first low-to-high transition on LDCK, either after a $\overline{\text{RST}}$ pulse or from an empty condition, causes $\overline{\text{EMPTY}}$ to go high and the data to appear on the Q outputs. The first word does not have to be unloaded. Data outputs are noninverting with respect to the data inputs and are at a high-impedance state when the output-enable (OE) input is low. The OE input does not effect either the $\overline{\text{FULL}}$ or $\overline{\text{EMPTY}}$ output flags. Cascading is easily accomplished in the word-width direction, but is not possible in the word-depth direction.

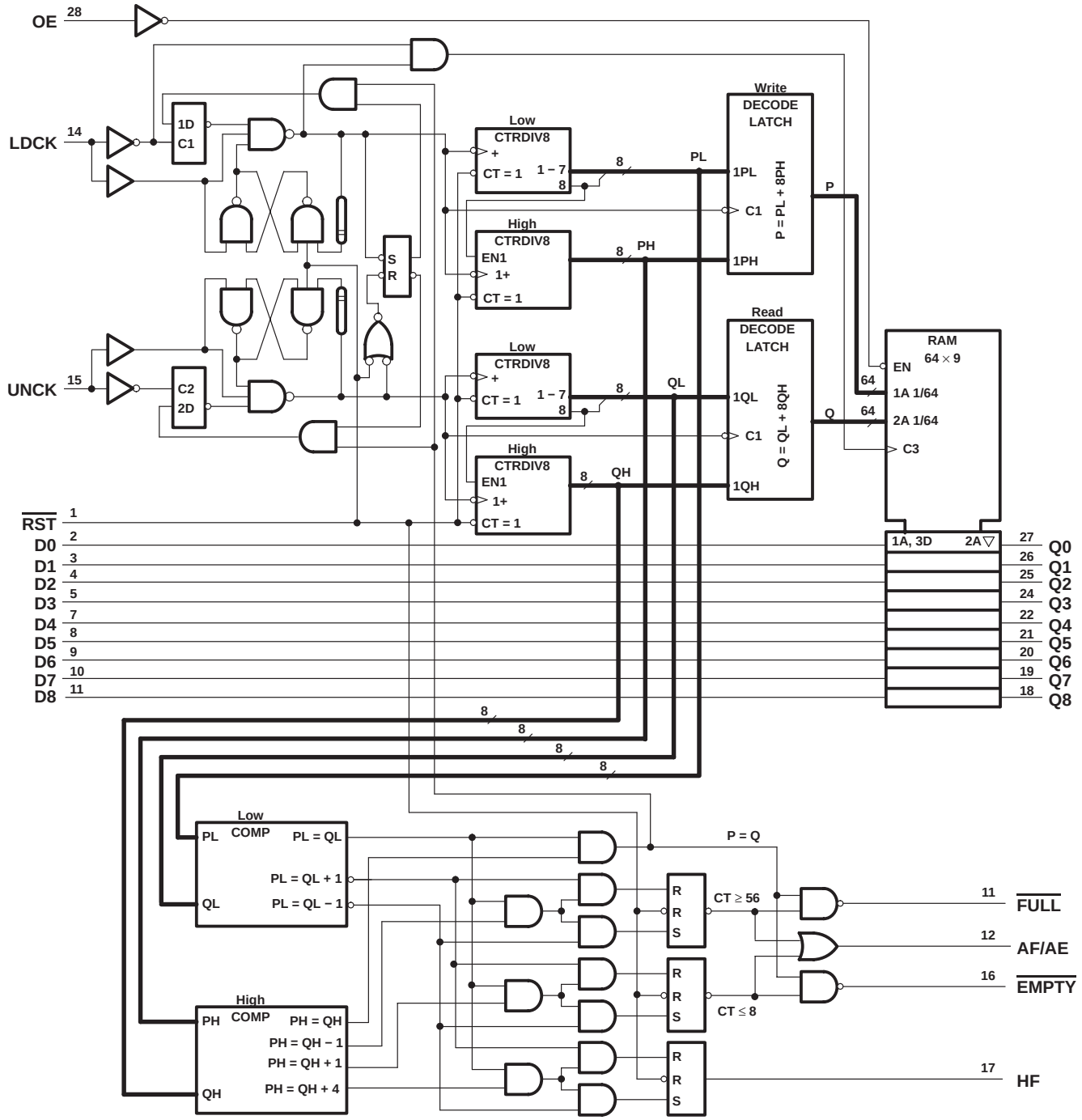
The SN74ALS2233A is characterized for operation from 0°C to 70°C.

logic symbol†

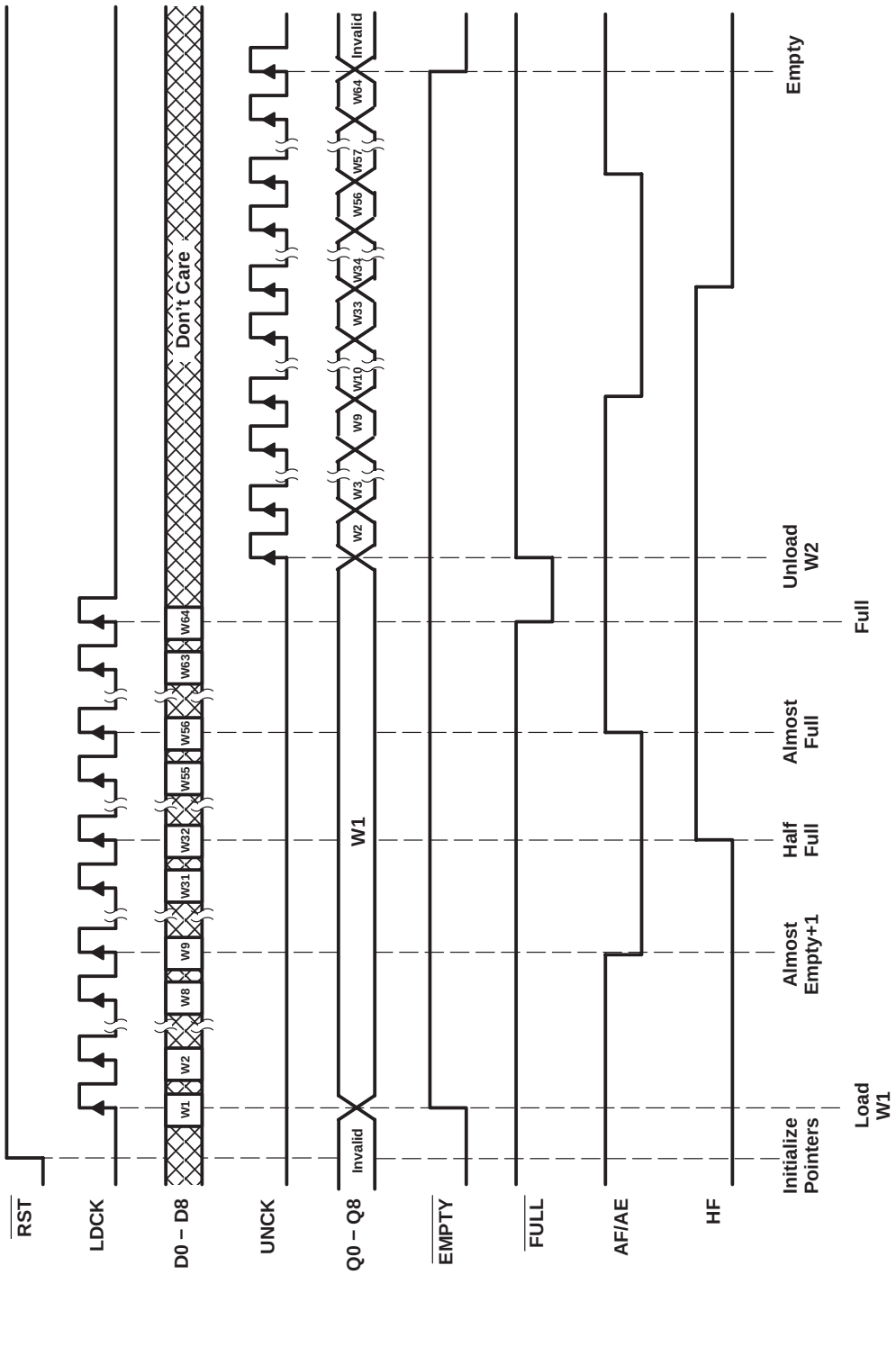


† This symbol is in accordance with ANSI/IEEE Standard 91-1984 and IEC Publication 617-12. The symbol is functionally accurate but does not show the details of implementation; for these, see the logic diagram. The symbol represents the memory as if it were controlled by a single counter whose content is the number of words stored at the time. Output data is invalid when the counter content (CT) is 0.

logic diagram (positive logic)



timing diagram



TEXAS INSTRUMENTS
POST OFFICE BOX 655303 • DALLAS, TEXAS 75265
POST OFFICE BOX 1443 • HOUSTON, TEXAS 77251−1443

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage, V_{CC} (see Note 1) . . . . . 7 V
Input voltage . . . . . 7 V
Voltage applied to a disabled 3-state output . . . . . 5.5 V
Operating free-air temperature range, T_A . . . . . 0°C to 70°C
Storage temperature range . . . . . − 65°C to 150°C

† Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. This is a stress rating only, and functional operation of the device at these or any other conditions beyond those indicated in the “recommended operating conditions” section of this specification is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTE 1: All voltage values are with respect to GND.

recommended operating conditions

			MIN	NOM	MAX	UNIT
V_{CC}	Supply voltage		4.5	5	5.5	V
V_{IH}	High-level input voltage		2			V
V_{IL}	Low-level input voltage				0.8	V
I_{OH}	High-level output current	Q outputs			−2.6	mA
		Flag outputs			−0.4	
I_{OL}	Low-level output current	Q outputs			24	mA
		Flag outputs			8	
f_{clock}	Clock frequency	LDCK, UNCK	0		40	MHz
t_w	Pulse duration	$\overline{RST}$ low	25			ns
		LDCK low	13			
		LDCK high	12			
		UNCK low	13			
		UNCK high	12			
t_{su1}	Setup time, data before LDCK↑		5			ns
t_{su2}	Setup time, $\overline{RST}$ high (inactive) before LDCK↑		5			ns
t_h	Hold time, data after LDCK↑		5			ns
T_A	Operating free-air temperature		0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

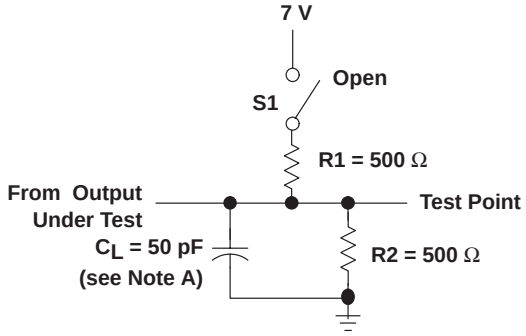
PARAMETER		TEST CONDITIONS†		MIN	TYP‡	MAX	UNIT
V_{IK}		V_{CC} = 4.5 V,	I_I = −18 mA			−1.2	V
V_{OH}	Q outputs	V_{CC} = 4.5 V,	I_{OH} = − 2.6 mA	2.4	3.2		V
	Flag outputs	V_{CC} = MIN to MAX,	I_{OH} = 0.4 mA	V_{CC} −2			
V_{OL}	Q outputs	V_{CC} = 4.5 V	I_{OL} = 12 mA		0.25	0.4	V
			I_{OL} = 24 mA		0.35	0.5	
	Flag outputs	V_{CC} = 4.5 V	I_{OL} = 4 mA		0.25	0.4	
			I_{OL} = 8 mA		0.35	0.5	
I_{OZH}		V_{CC} = 5.5 V,	V_O = 2.7 V			20	µA
I_{OZL}		V_{CC} = 5.5 V,	V_O = 0.4 V			−20	µA
I_I		V_{CC} = 5.5 V,	V_I = 7 V			0.1	mA
I_{IH}		V_{CC} = 5.5 V,	V_I = 2.7 V			20	µA
I_{IL}	CLKs	V_{CC} = 5.5 V,	V_I = 0.4 V			−0.2	mA
	Others					−0.1	
I_O§	Q outputs	V_{CC} = 5.5 V,	V_O = 2.25 V	−20		−130	mA
	Flag outputs			−20		−112	
I_{CC}		V_{CC} = 5.5 V			175	290	mA

† For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.
‡ All typical values are at V_{CC} = 5 V, T_A = 25°C.
§ The output conditions have been chosen to produce a current that closely approximates one half of the true short-circuit output current, I_{OS}.

switching characteristics (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V_{CC} = 5 V, C_L = 50 pF, R1 = 500 Ω, R2 = 500 Ω, T_A = 25°C			V_{CC} = 4.5 V to 5.5 V, C_L = 50 pF, R1 = 500 Ω, R2 = 500 Ω, T_A = 0°C to 70°C		UNIT
			MIN	TYP	MAX	MIN	MAX	
f_{max}	LDCK, UNCK					40		MHz
t_{pd}	LDCK↑	Any Q		18	26		30	ns
	UNCK↑			18	24		27	
t_{PLH}	LDCK↑	$\overline{EMPTY}$		12	16		18	ns
t_{PHL}	UNCK↑			12	17		20	
t_{PHL}	$\overline{RST}$↓	$\overline{EMPTY}$		12	17		20	ns
t_{PHL}	LDCK↑	$\overline{FULL}$		16	21		22	ns
t_{PLH}	UNCK↑	$\overline{FULL}$		10	15		18	ns
	$\overline{RST}$↓			13	19		23	
t_{PLH}	LDCK↑	AF/AE		22	27		30	ns
t_{PHL}				19	25		28	
t_{PLH}	UNCK↑	AF/AE		22	27		30	ns
t_{PHL}				17	23		26	
t_{PLH}	$\overline{RST}$↓	AF/AE		12	16		18	ns
t_{PLH}	LDCK↑	HF		22	27		30	ns
t_{PHL}	$\overline{RST}$↓			28	32		35	
t_{PHL}	UNCK↑	HF		16	22		25	ns
t_{en}	OE↑	Q		11	15		17	ns
t_{dis}	OE↓	Q		11	17		19	ns

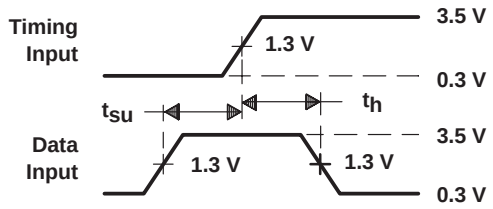
PARAMETER MEASUREMENT INFORMATION



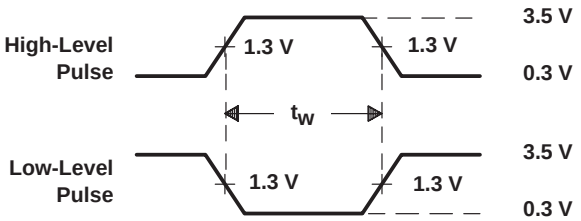
LOAD CIRCUIT FOR 3-STATE OUTPUTS

SWITCH POSITION TABLE

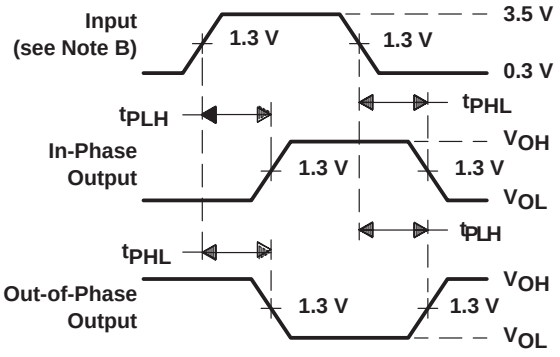
TEST	S1
t_{PLH}	Open
t_{PHL}	Open
t_{PZH}	Open
t_{PZL}	Closed
t_{PHZ}	Open
t_{PLZ}	Closed



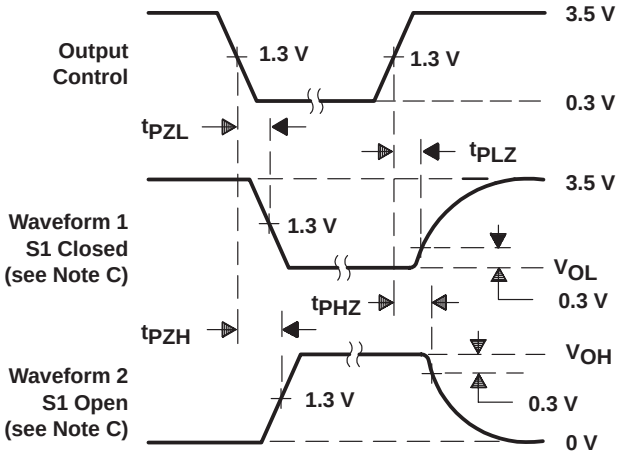
VOLTAGE WAVEFORMS
SETUP AND HOLD TIMES



VOLTAGE WAVEFORMS
PULSE DURATION



VOLTAGE WAVEFORMS
PROPAGATION DELAY TIMES



VOLTAGE WAVEFORMS
ENABLE AND DISABLE TIMES, 3-STATE OUTPUTS

NOTES: A. C_L includes probe and jig capacitance.
B. All input pulses are supplied by generators having the following characteristics: PRR ≤ 1 MHz, Z_O = 50 Ω, t_r ≤ 2 ns, t_f ≤ 2 ns.
C. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
D. The outputs are measured one at a time with one transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms

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